*PATENT* 0106-P0100A

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## TRADEMARK OFFICE

Applicants	Sang Soo Oh, <i>et al.</i>
Application No. Pending	Filing Date: January 12, 2007
Title of Application:	Method And Apparatus For Fabricating High Temperature Superconducting Film

Mail Stop Assignment Recordation Services Director, U.S. Patent and Trademark Office Post Office Box 1450 Alexandria, VA 22313-1450



## Patent Assignment Recordation Form Cover Sheet

Dear Sir:

Please record the attached original document.

- 1. <u>Name of conveying parties:</u> Sang Soo Oh, Ho Seop Kim, Kyu Jung Song, Do Jun Youm, Sun Mi Lim, Yong Hwan Jung, Sang Moo Lee, Ye Hyun Jung, Jae Eun Yoo
- 2. <u>Name and Address of Receiving Party:</u> Korean Electrotechnology Research Institute; 28-1, Seongju-dong, Changwon-si, Gyeonsangnam-do, Republic of Korea.
- 3. <u>Nature of Conveyance</u>: Assignment. <u>Execution Date</u>: December 15, 2006.
- 4. Name and Address of Party to Whom Correspondence Concerning Document should be mailed:

Hyun Jong Park, Registration No. 59,093
Attorney for Applicants
TUCHMAN & PARK LLC
41 White Birch Road
Redding, CT 06896-2209
Tel. (203) 702-7102

01/17/2007 SSITHIB1 00000052 11653170 05 FC:8021 40.00 OP

- 5. <u>Application Number</u>: This document is being filed together with a new application, which is also filed herewith.
- 6. Total Number of Applications Involved: 1.

- 7. Total Fee (37 CFR 3.41): \$40.00 due. This amount has been added to the Application fee which is enclosed.
- Statement and Signature. Total number of pages including cover sheet, attach-8. ments and document are 8. To the best of my knowledge and belief, the foregoing information is true and correct and any copy submitted herewith is a true copy of the original document.

Respectfully submitted,

January 12, 2007

Hyun Jong Park, Registration No. 59,093

**Attorney for Applicants** TUCHMAN & PARK LLC 41 White Birch Road Redding, CT 06896-2209

(203) 702-7102

## **Assignment**

WHEREAS, I/we, the undersigned inventor(s), have made certain inventions or
discoveries (or both) as set forth in an application for Letters Patent of the United States
of America, entitled METHOD AND APPARATUS FOR FABRICATING HIGH
TEMPERATURE SUPERCONDUCTING FILM THROUGH AUXILIARY CLUSTER
BEAM SPRAYING, AND HIGH TEMPERATURE SUPERCONDUCTING FILM
FABRICATED USING THE METHOD, bearing Patent Application Serial No.
; filed on;
WHEREAS, Korea Electrotechnology Research Institute, organized and existing
under the laws of Republic of Korea, whose address is 28-1, Seongiu-dong
Changwon-si, Gyeonsangnam-do, Republic of Korea,

and, together with its successors and assigns is hereinafter called "Assignee", and is desirous of acquiring the title, rights, benefits and privileges hereinafter recited;

NOW THEREFORE, for valuable consideration furnished by Assignee to me/us, receipt and sufficiency of which I/we hereby acknowledge, I/we hereby, without reservation:

- 1. Assign, transfer and convey to Assignee the entire right, title and interest in and to said inventions and discoveries, said application for Letters Patent of the United States of America, any and all other applications for Letters Patent on said inventions and discoveries in whatsoever countries, including all divisional, renewal, substitute, continuation and convention applications based in whole or in part upon said inventions or discoveries, or upon said applications, and any and all Letters Patent, reissues and extensions of Letters Patent granted for said inventions and discoveries or upon said applications, and every priority right that is or may be predicated upon or arise from said inventions, said discoveries, said applications and said Letters Patent;
- 2. Authorize Assignee to file patent applications in any or all countries on any or all of said inventions and discoveries in my/our name(s) or in the name of Assignee or otherwise as Assignee may deem advisable, under the International Convention or otherwise:
- 3. Authorize and request the Commissioner of Patents of the United States of America and the empowered officials of all other governments to issue or transfer all said Letters Patents to Assignee, as assignee of the entire right, title and interest therein or otherwise as Assignee may direct;
- 4. Warrant that I/we have not knowingly conveyed to others any right in said inventions, discoveries, applications or patents or any license to use the same or to make, use or sell anything embodying or utilizing any of said inventions or discoveries; and that I/we have good right to assign the same to Assignee without encumbrance;
- 5. Bind my/our heirs, legal representatives and assigns, as well as myself/ourselves, to do, upon Assignee's request and at Assignee's expense, but

without additional consideration to me/us or them, all acts reasonably serving to assure that said inventions and discoveries, said patent applications and said Letters Patent shall be held and enjoyed by Assignee as fully and entirely as the same could have been held and enjoyed by me/us, my/our heirs, legal representatives and assigns if this assignment had not been made; and particularly to execute and deliver to Assignee all lawful application documents, including petitions, specifications, and oaths, and all assignments, disclaimers, and lawful affidavits in form and substance as may be requested by Assignee; to communicate to Assignee all facts known to me/us relating to said inventions and discoveries or the history thereof; and to furnish Assignee with any and all documents, photographs, models, samples and other physical exhibits in my/our control or in the control of my/our heirs, legal representatives or assigns, which may be useful for establishing the facts of my/our conceptions, disclosures, and reduction to practice of said inventions and discoveries.

IN WITNESS WHEREOF, I/we the inventor(s),

	have		
hereunto duly executed this Assignment.			
Say-Goo Off	•••••		
Signature of Sole or Files Inventor			
OH, Sang Soo 2006, 12.	15		
Full Name of Sole or First Inventor (please print)  Date			
Declaration of Witness for Sole or First Inventor  I declare that I was personally present and did see, who is personally known to me to be the person named in this assignment, duly sign and execute the same.			
Declared at, on			
Signature of Witness  Kim No Seop  Full Name of Witness			

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Signature of Second Inventor	
KIM, Ho Seop	Dec 15. 2006
Full Name of Second Inventor (please pr	int) Date
Declaration of Wita	ness for Second Inventor
I declare that I was personally prime to be the person named in this assign	esent and did see, who is personally known to nment, duly sign and execute the same.
Declared at	, on
	Jam
	Signature of Witness
	Kim, Ho Seop
	Full Name of Witness
Kynteony Song	
Signature of Third Inventor	
SONG, Kyu Jung	Dec. 15, 2006
Full Name of Third Inventor (please print	
<u>Declaration of W</u>	itness for Third Inventor
	resent and did see, who is personally known to inment, duly sign and execute the same.
Declared at	, on
	Jupa
	Signature of Witness
	Kim, Ho Seop
	Full Name of Witness '

Page 3 Assignment

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Signature of Fourth Inventor	
YOUM, Do Jun	Dec 7, 2006
Full Name of Fourth Inventor (please pri	
Declaration of Wit	tness for Fourth Inventor
I declare that I was personally pr me to be the person named in this assig	resent and did see, who is personally known to nment, duly sign and execute the same.
Declared at	, on
	me
	Signature of Witness
•	Lec, Jae young
	Full Name of Witness
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M	
Signature of Fifth Inventor	<del></del>
LIM Cup Mi	Dec 7. 2006
LIM, Sun Mi Full Name of Fifth Inventor (please print	
Declaration of V	Vitness for Fifth Inventor
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	resent and did see, who is personally known to anment, duly sign and execute the same.
•	•
Declared at	, on
	Signature of Witness
	Lee, Jae young Full Name of Witness
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Page 4 Assignment

Page 5 Assignment		
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Signature of Sixth Inventor	_	
JUNG, Yong Hwan	2006, 12. 7	
Full Name of Sixth Inventor (please print)	Date	
<b>Declaration of Witness</b>	for Sixth Inventor	
I declare that I was personally present and did see, who is personally known to me to be the person named in this assignment, duly sign and execute the same.		
Declared at	, on	
	Zort Ev	
Signa	iture of Witness	
	Lee, Jae Youmay	
Full N	lame of Witness	
Signature of Seventh Inventor		
LEE, Sang Moo	2006, 12.7.	
Full Name of Seventh Inventor (please print)	Date	
<b>Declaration of Witness for Seventh Inventor</b>		
I declare that I was personally present and did see, who is personally known to me to be the person named in this assignment, duly sign and execute the same.		
Declared at	, on	
Declared at	, on	
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Signa	Au	

(Duc)		
Signature of Eighti Inventor		
JUNG, Ye Hyun	2006.12.12	
JUNG, Ye Hyun Full Name of Eighth Inventor (please pri	nt) Date	
<u>Declaration of W</u>	itness for Eighth Inventor	
I declare that I was personally present and did see, who is personally known to me to be the person named in this assignment, duly sign and execute the same.		
Declared at	, on	
	1 10	
	Signature of Witness	
	Kim Ha Seap	
	Full Name of Witness	
Jaeun For		
Signature of Nineth Inventor		
YOO, Jae Eun	2006.12.7	
Full Name of Nineth Inventor (please pr	rint) Date	
Declaration of Witness for Nineth Inventor		
I declare that I was personally present and did see, who is personally known to me to be the person named in this assignment, duly sign and execute the same.		
Declared at	, on	
,		
	AND	
	Signature of Witness	
	Lee, Jae Young Full Name of Witness	
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**RECORDED: 01/12/2007** 

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